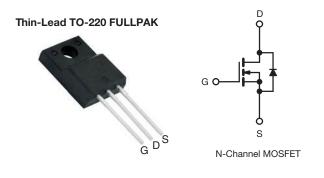
## SiHA20N50E

**Vishay Siliconix** 



### **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550				
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.184				
Q <sub>g</sub> max. (nC)	92				
Q <sub>gs</sub> (nC)	10				
Q <sub>gd</sub> (nC)	19				
Configuration	Single				

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA20N50E-E3			
Lead (Pb)-free and halogen-free	SiHA20N50E-GE3			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	500	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain surrant $(T_{1} - 150 \circ C)^{\frac{1}{2}}$	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	19		
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup>	VGS AL TO V	T <sub>C</sub> = 100 °C		12	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	42	1	
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	204	mJ	
Maximum power dissipation			PD	34	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V t$	o 80 % V <sub>DS</sub>	d\//dt	70	1//20	
Reverse diode dV/dt <sup>d</sup>			dV/dt	32	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,~I_{AS}$  = 3.8 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, dl/dt$  = 100 A/µs, starting  $T_J$  = 25 °C

e. Limited by maximum junction temperature

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DADAMETER	CVMDOI	T\/D		LAN			LINUT		
PARAMETER	SYMBOL	TYP.			MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 65			°C/W				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 3.7							
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	Inless otherwi	ise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UN		
Static					1	1			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		500	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub>	= 1 mA	-	0.59	-	V/°	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 25	i0 μA	2.0	-	4.0	V	
		,	$V_{GS} = \pm 20 V$		-	-	± 100	n/	
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V		-	-	± 1	μı	
Zoro gato voltago drain ourront		V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> =	= 0 V	-	-	1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 400 V$	/, V <sub>GS</sub> = 0 V, <sup>•</sup>	T <sub>J</sub> = 125 °C	-	-	10	μ	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> :	= 10 A	-	0.160	0.184	Ω	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 10 A		-	4.4	-	9	
Dynamic		-			-	-			
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1640	-	pF		
Output capacitance	C <sub>oss</sub>			-	87	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-			
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	73	-			
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	222	-			
Total gate charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 10 A, V <sub>DS</sub> = 400 V		-	46	92	nC		
Gate-source charge	Q <sub>gs</sub>			-	10	-			
Gate-drain charge	Q <sub>gd</sub>				-	19	-		
Turn-on delay time	t <sub>d(on)</sub>		V <sub>DD</sub> = 400 V, I <sub>D</sub> = 10 A,		-	17	34		
Rise time	t <sub>r</sub>	V <sub>DD</sub> =			-	27	54		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	48	96	- ns		
Fall time	t <sub>f</sub>			-	25	50			
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	0.83	-	2		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	,		
Pulsed diode forward current	I <sub>SM</sub>			-	-	42	A		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 10 A, V	$V_{\rm GS} = 0  \rm V$	-	-	1.2	١	
Reverse recovery time	t <sub>rr</sub>			10.4	-	293	-	n	
Reverse recovery charge	Q <sub>rr</sub>	$ T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 10 \text{ A}, $ dl/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		-	4.0	-	μ		
Reverse recovery current	I <sub>RRM</sub>			-	26	-	A		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## SiHA20N50E

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

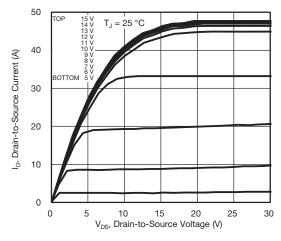


Fig. 1 - Typical Output Characteristics

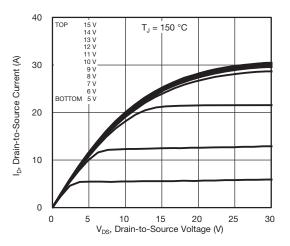


Fig. 2 - Typical Output Characteristics

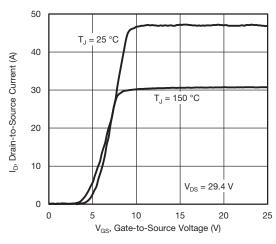


Fig. 3 - Typical Transfer Characteristics

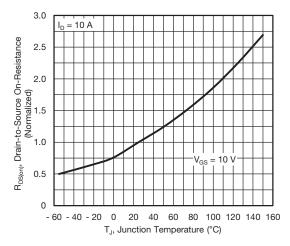


Fig. 4 - Normalized On-Resistance vs. Temperature

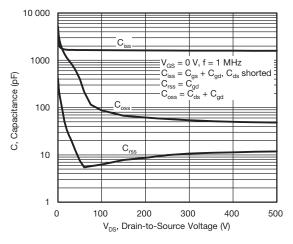


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

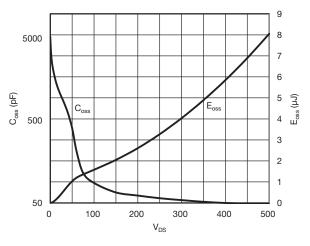


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

3 questions contact: hym@vi

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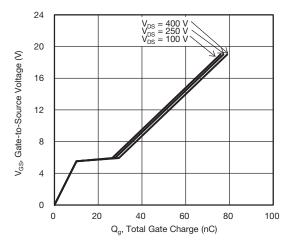


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

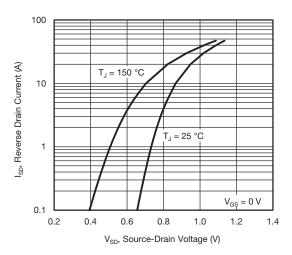
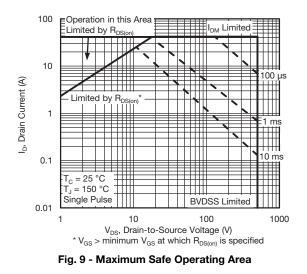


Fig. 8 - Typical Source-Drain Diode Forward Voltage



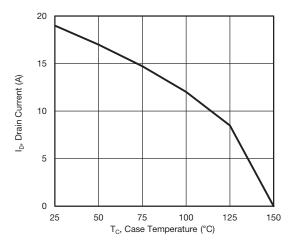


Fig. 10 - Maximum Drain Current vs. Case Temperature

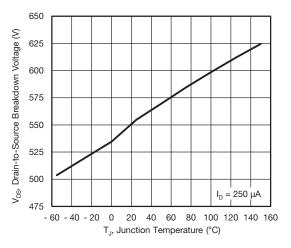
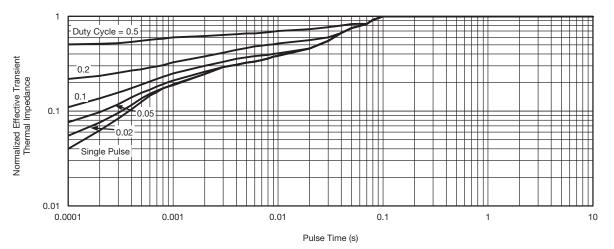


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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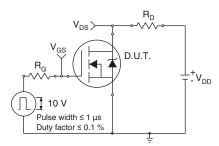


Fig. 13 - Switching Time Test Circuit

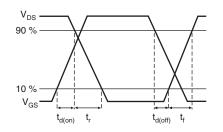


Fig. 14 - Switching Time Waveforms

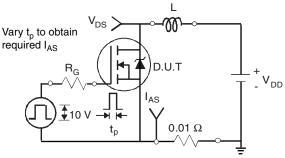


Fig. 15 - Unclamped Inductive Test Circuit

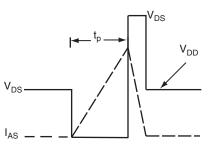


Fig. 16 - Unclamped Inductive Waveforms

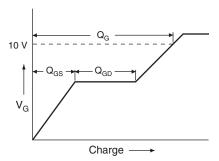


Fig. 17 - Basic Gate Charge Waveform

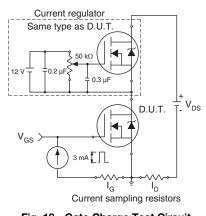


Fig. 18 - Gate Charge Test Circuit

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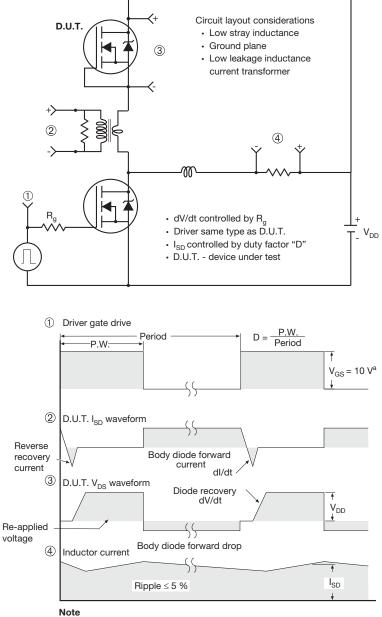
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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